



# Inkjet Printed diF-TES-ADT Organic Thin Film Transistors

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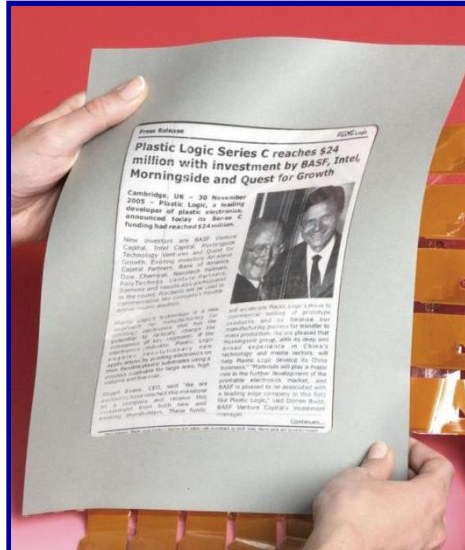
<sup>4</sup>Department of Chemistry, University of Kentucky

# Organic Electronics

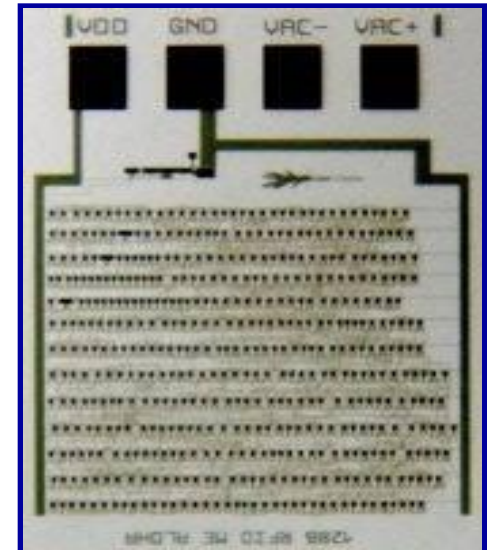
Wide range of potential low cost, large area, organic semiconductor applications



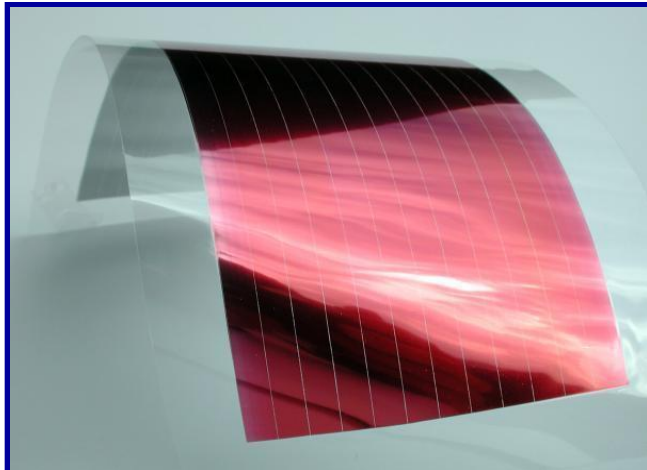
SONY OTFT AMOLED display



Plastic Logic e-paper



Holst Centre RFID



Fraunhofer ISE Solar cell



BIOIDENT Biosensors

# Solution-Processable Organic Semiconductors

Many large area electronic applications will be cost driven

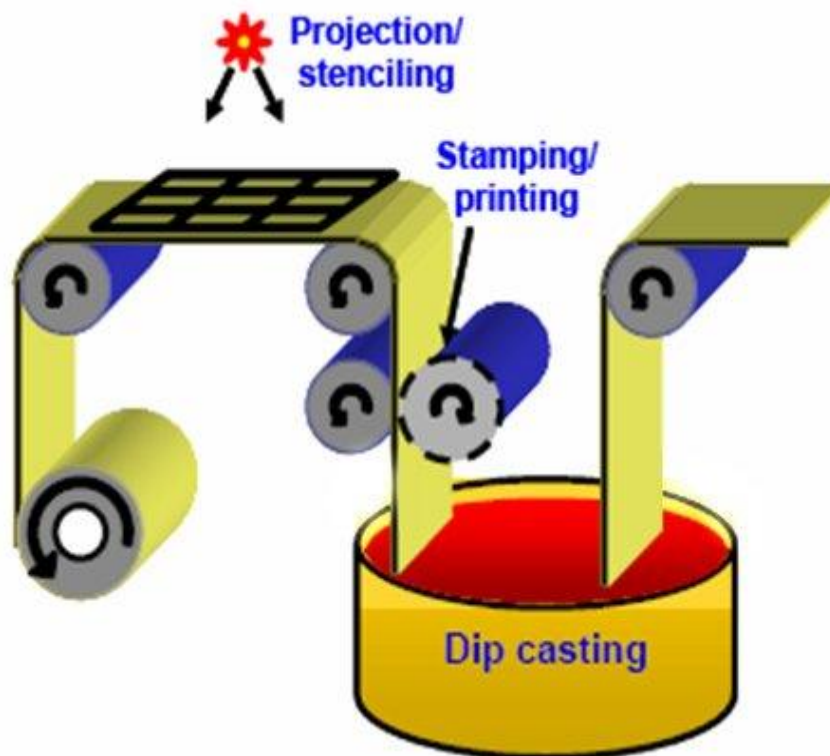
Cost of vapor deposited organic semiconductor  
is likely to be similar to current inorganic

→ Need solution processable organic semiconductors

Polymers, pentacene precursor,  
soluble rubrene, et cetera

For low cost processing:

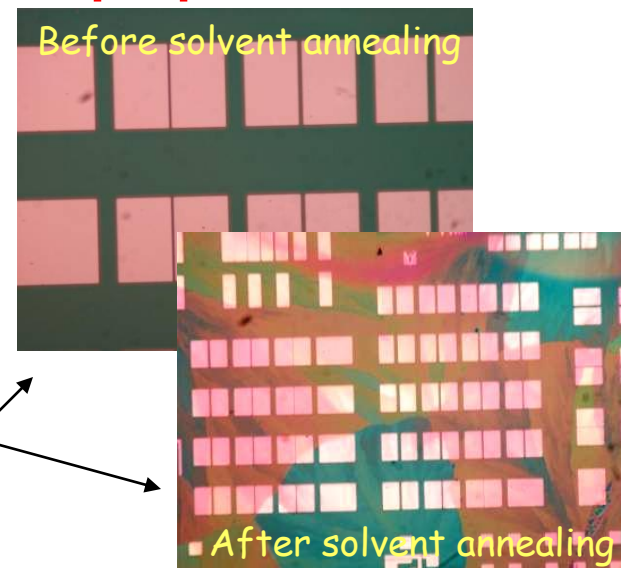
- Additive processes
- Arbitrary substrates
- Possibly roll-to-roll



**Small molecule organic semiconductors use molecular design to drive device properties**

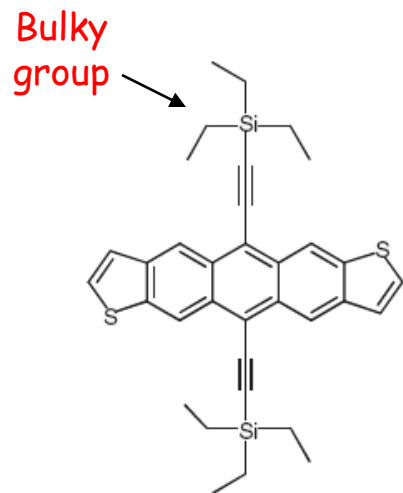
**TES-ADT uses bulky groups for solubility and backbone design (anthracene core, thiophene ends) for molecular ordering**

**Spin cast TES-ADT, amorphous as deposited, forms well-ordered thin films after solvent vapor annealing**

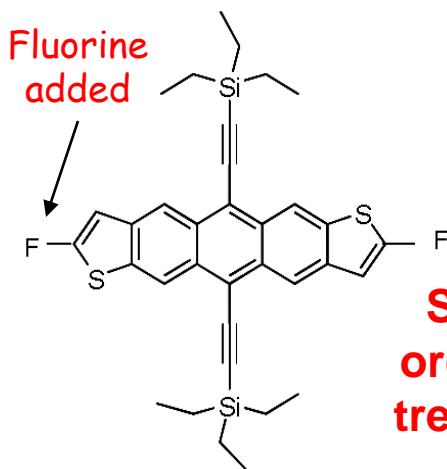


**Fluorine added to diF TES-ADT gives surface feature related differential microstructure**

**Spin cast diF TES-ADT forms well-ordered thin films on and near PFBT\* treated Au electrodes, poorly ordered films on HMDS treated SiO<sub>2</sub>**



Triethylsilylethynyl anthradithiophene (TES-ADT)

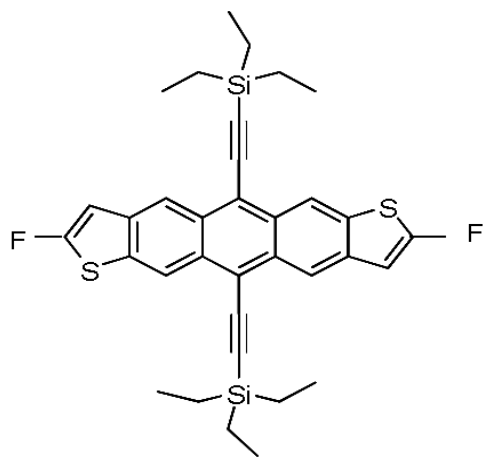


5,11-Bis(triethylsilylethynyl) anthradithiophene (diF TES-ADT)

\*pentafluorobenzenethiol

# Small Molecular Organic Semiconductor Transistors

**X-ray diffraction shows strong ordering for solution-deposited thin films**



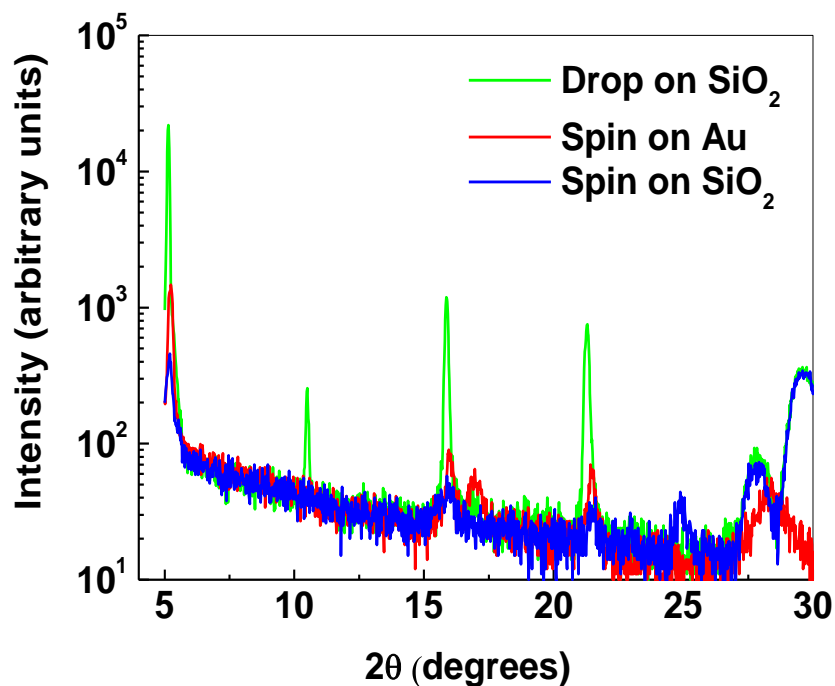
**diF TES-ADT**



**Drop coated diF-TES-ADT**



**Spin coated diF-TES-ADT**



**High mobility OTFTs have been fabricated with both drop coated and spin coated diF TES-ADT**

**Drop coated TFTs ~ 2 cm<sup>2</sup>/V·s**

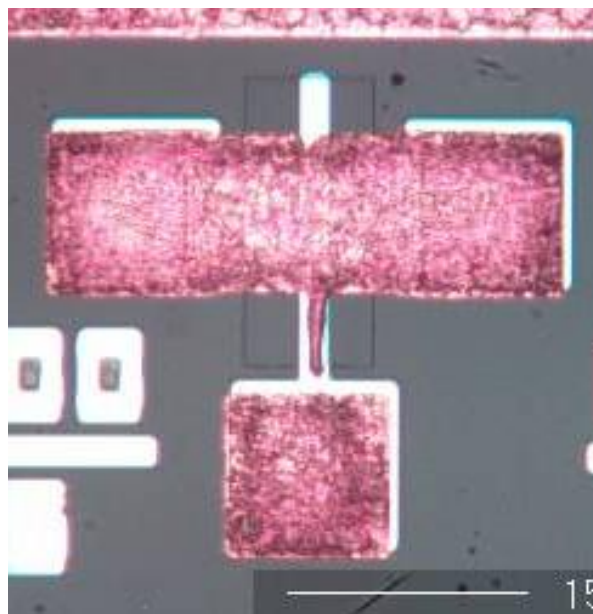
**Spin coated TFTs ~ 1.5 cm<sup>2</sup>/V·s\***

\*S.K.Park et. al, *App. Phys. Lett.*, 93, 043301 (2008)

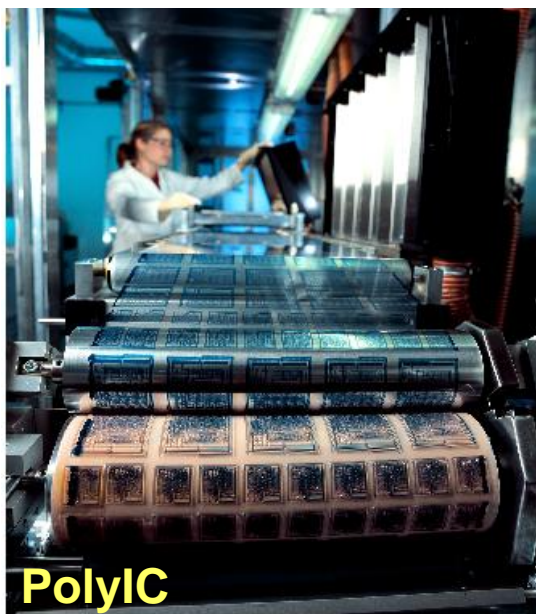
# Organic Semiconductor Patterning

**Need low-cost, simple, organic semiconductor patterning**

**Conventional lithography may be a barrier for low-cost mass-production of organic electronics**



**Non-relief pattern lithography\***



**Printing**

## **Ink-jet printing**

- **Non-contact patterning**
- **Low material usage (additive process)**
- **Digital control patterning**

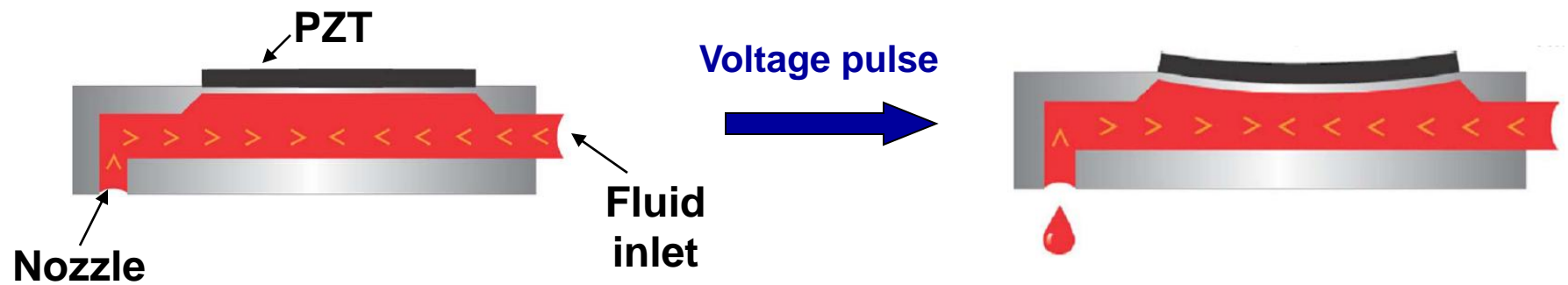


**Dimatix 2381 Inkjet Printer**

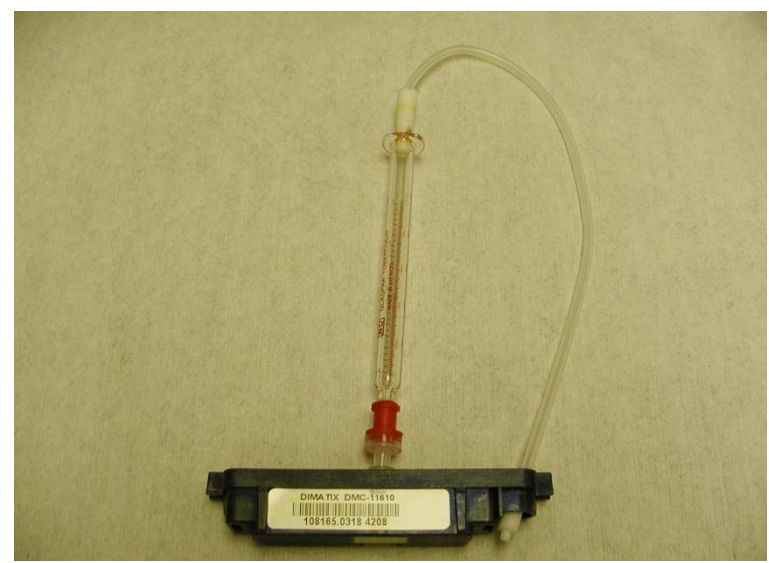
\*S.K.Park et. al, *Adv. Mater.*, 2008, 20, 1-3

# Inkjet Printing

## Piezoelectric ink-jet printing



**Slightly modified printhead cartridges allow small amounts of printing material to be conveniently used**



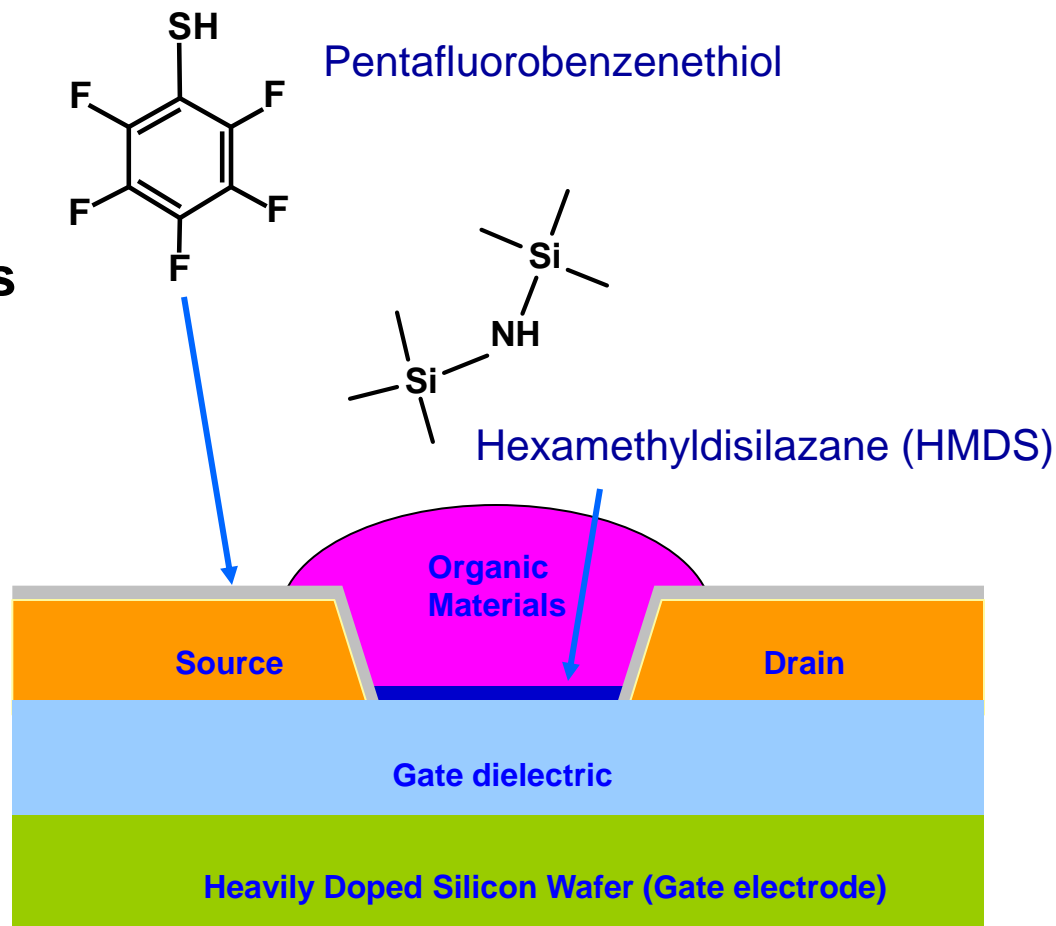
## Simple OTFT test structure

Oxidized silicon wafer  
used as gate, gate  
dielectric, and substrate

Au source and drain electrodes

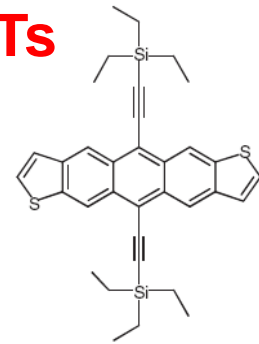
Self-assembled monolayers  
often used to modify  
electrodes and dielectric:

- PFBT SAM on source and drain electrodes
- HMDS on SiO<sub>2</sub> gate dielectric

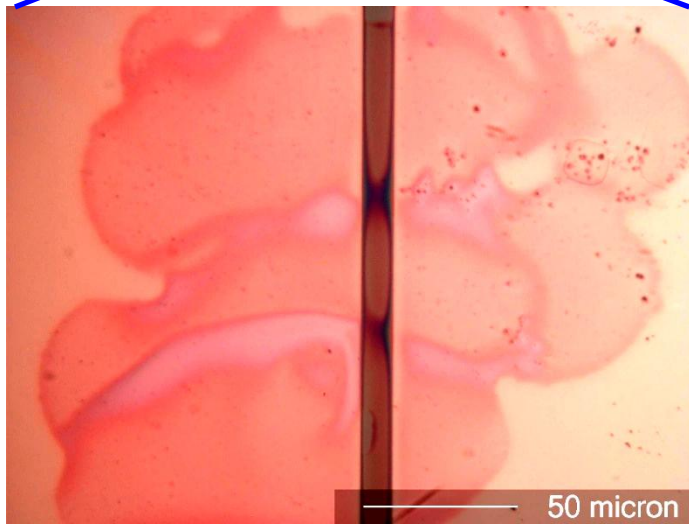
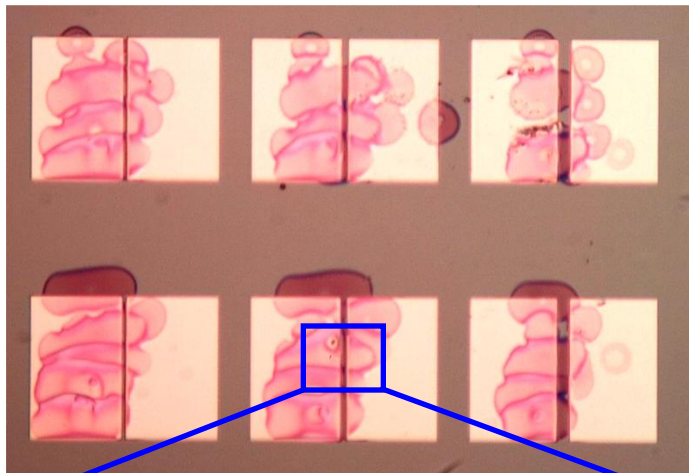


# Inkjet Printed TES-ADT OTFT

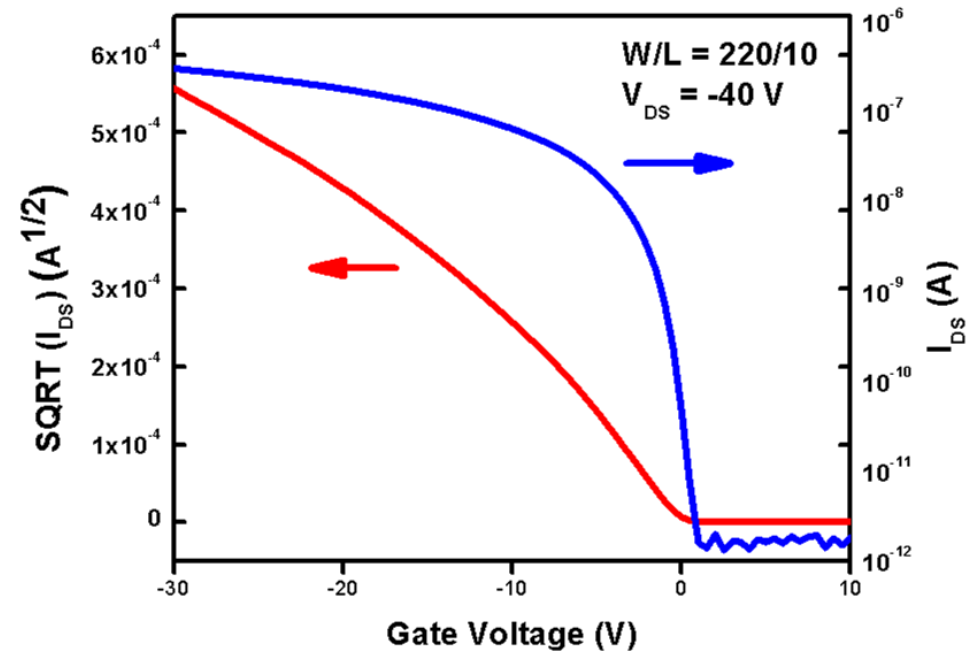
Solutions of TES-ADT are simple to inkjet print, but result in poorly ordered films and low mobility OTFTs



Printed TES-ADT films appear amorphous with no crystal domains & no change after solvent annealing



Printed from 2 wt% TES-ADT in toluene

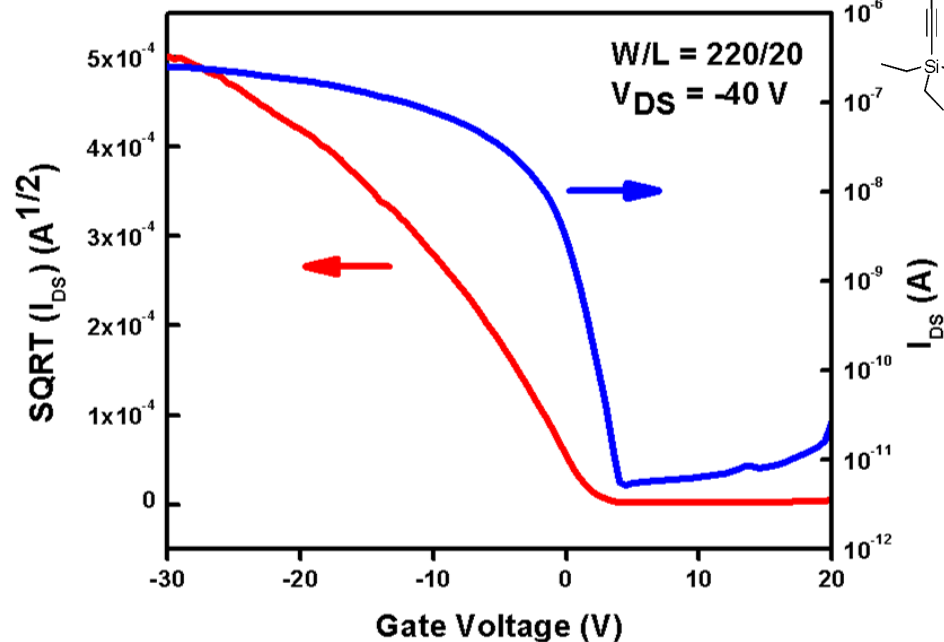
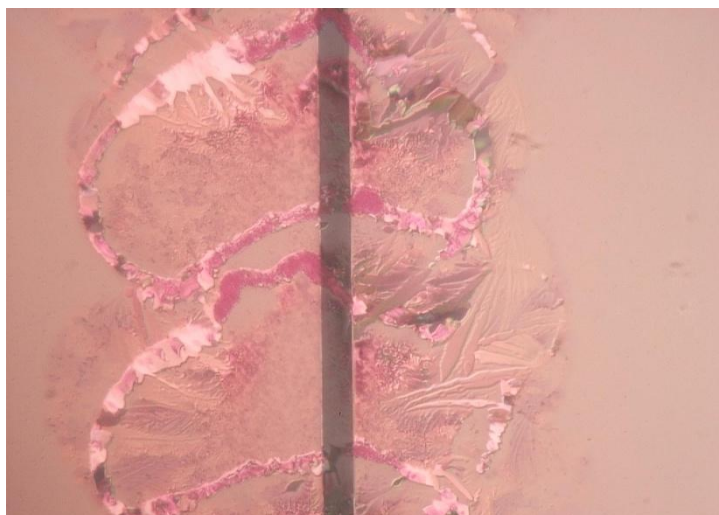
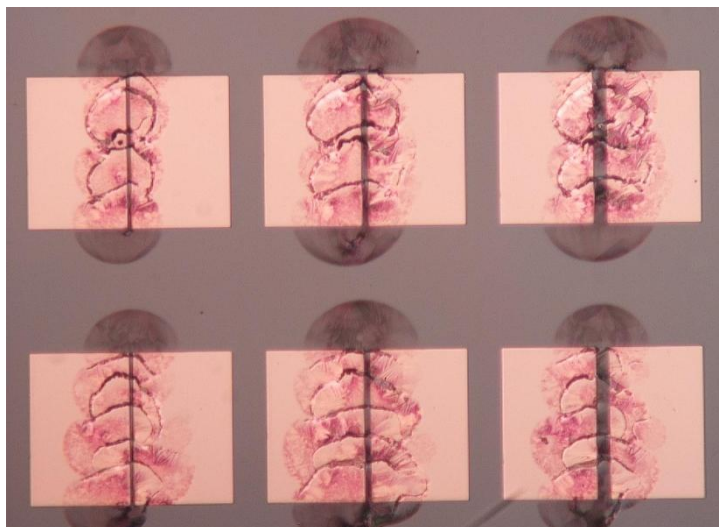
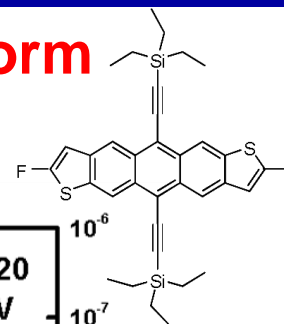


- As printed field effect mobility  $\sim 2 \times 10^{-2} \text{ cm}^2/\text{V}\cdot\text{s}$
- No change with solvent annealing



# Inkjet Printed diF-TES-ADT OTFT

**Inkjet printed diF TES-ADT films have small, non-uniform crystal domains, but only slightly higher mobility**



Field effect mobility  $\sim 5 \times 10^{-2} \text{ cm}^2/\text{V}\cdot\text{s}$

**Guess: chlorobenzene (bp 132 °C) evaporates too fast & leads to incoherent crystal domains**

**→ Try higher boiling point solvent**

Printed from 2 wt% diF TES-ADT in chlorobenzene

# Inkjet Printing with High Boiling Point Solvent

**Trichlorobenzene (bp 214 °C), gives large domains, but does not readily wet treated surfaces**

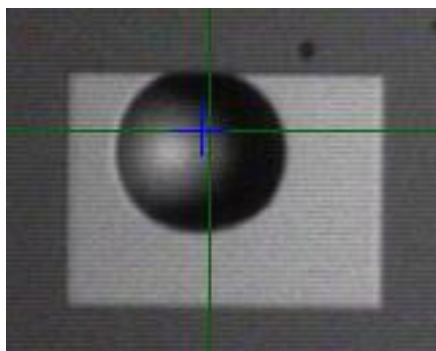
Ink-jet from 1 wt% in 1,2,4-trichlorobenzene (BP ~ 214 °C)



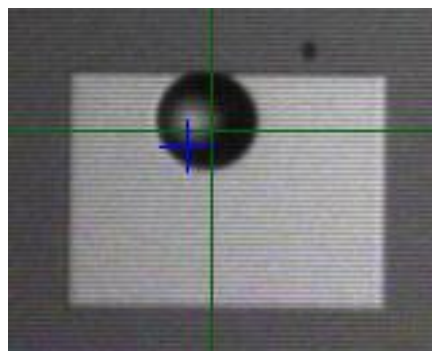
**Large domains result when drop finally dries**

**Drying drop moves on treated surface**

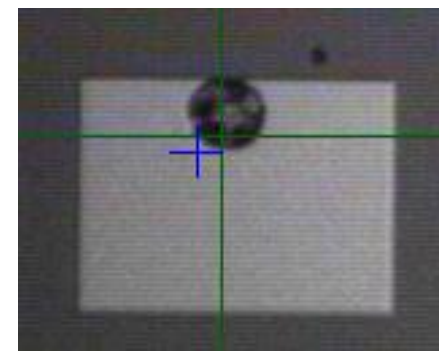
**Inkjet printed diF-TES ADT droplet drying on PFBT treated Au**



**10 s**



**20 s**

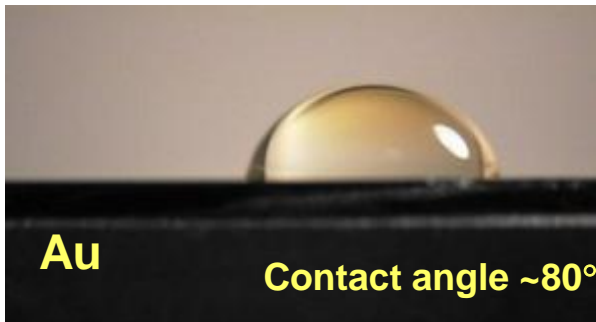


**30 s**

# Surface Energy and Wetting

**PFBT and HMDS treated surfaces have low surface energy and allow the contact line to recede during drying**

**PFBT treated Au:**

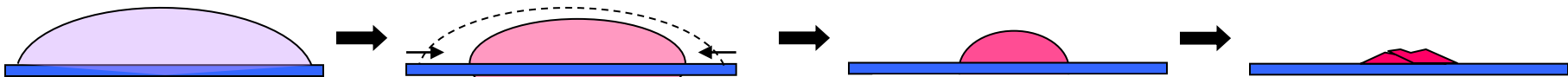


**PFBT treated and HMDS treated SiO<sub>2</sub>:**



DI water was used as liquid for contact angle measurement

**Evaporation of a droplet printed on a low energy surface:**

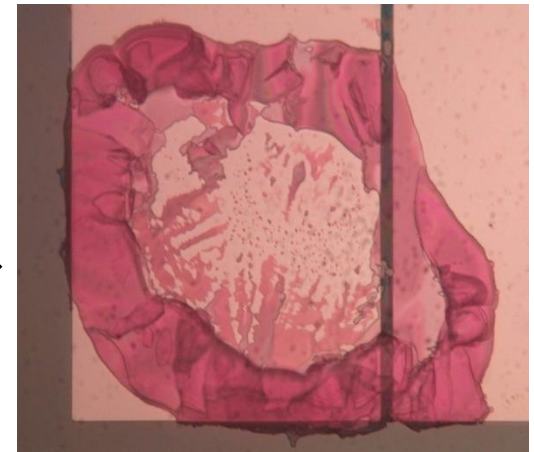
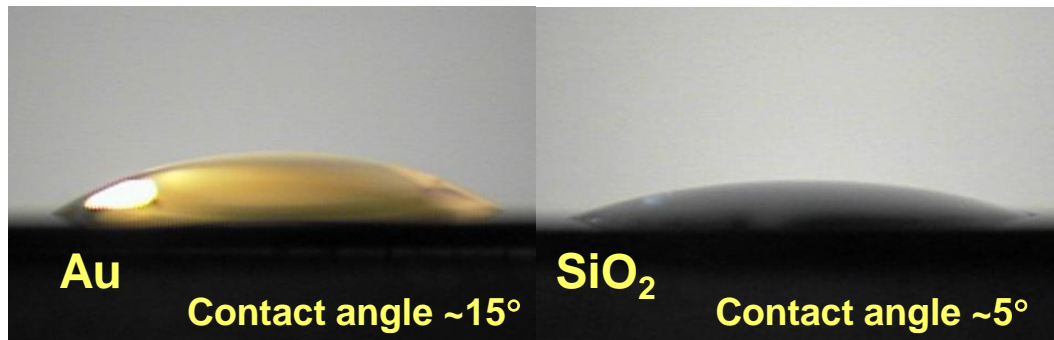


**Droplet diameter decreases as drying proceeds, finally, solid material is deposited**

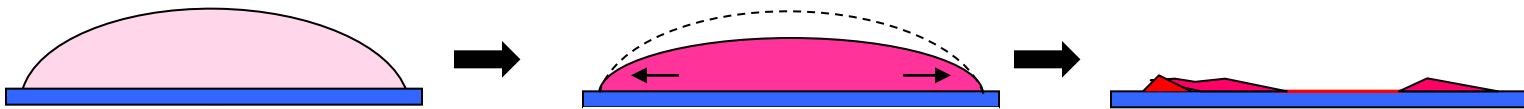
# High Surface Energy

## High energy surface improves wetting

UV-ozone treatment results  
in high surface energy



Evaporation of a droplet printed on a high energy surface:



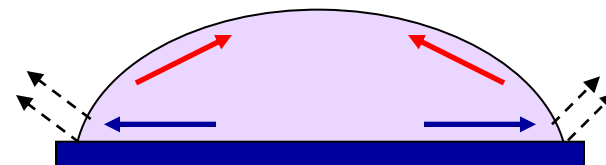
“Coffee-stain” effect\* caused by pinned  
contact line and outward convective flow

\*R.D.Deegan et. al, Nature 1997,389,827

# Inkjet Printing from Mixed Solvents

**Mixed solvents can allow control of substrate wetting and hydrodynamic flow in drying droplets\***

**“Coffee stain” behavior of ink-jet-printed organic semiconductor films avoided by balancing Marangoni and convective flows\***



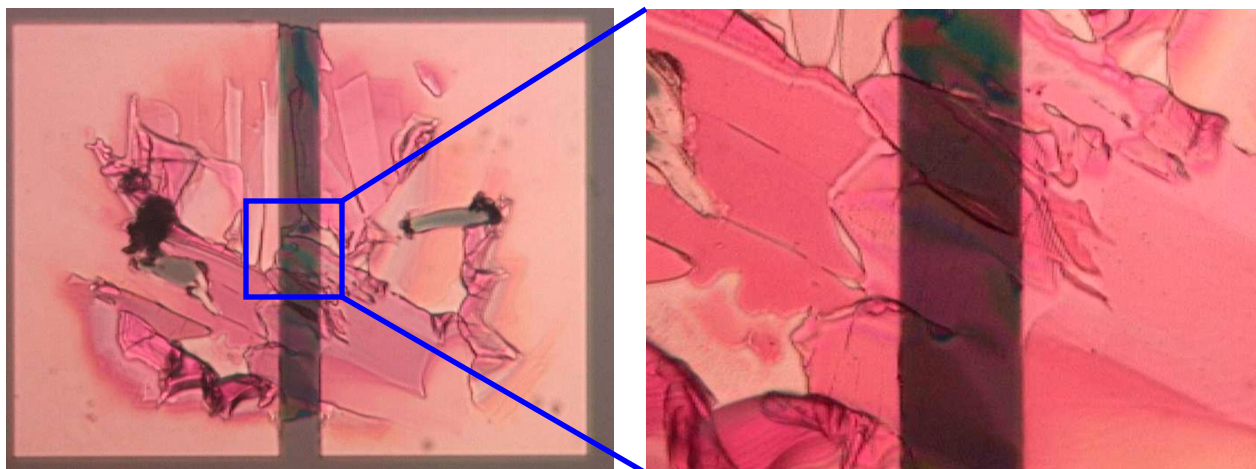
**→ Marangoni flow**

**→ Convective flow**

**- - → Evaporation**

**Chlorobenzene, boiling point 132 °C,  
high surface tension**

**1,2,4-trichlorobenzene, boiling point  
214 °C, low surface tension**



**No “Coffee Stain”**

**Large crystals  
across channel  
region**

\*J.A.Lim et. al, *Adv. Funct., Mat*,  
18, pp. 1-11 (2008)



# Inkjet Printed F-TES-ADT OTFT



**Inkjet printed OTFT with mixed solvents has mobility higher than 0.4 cm<sup>2</sup>/V·s**

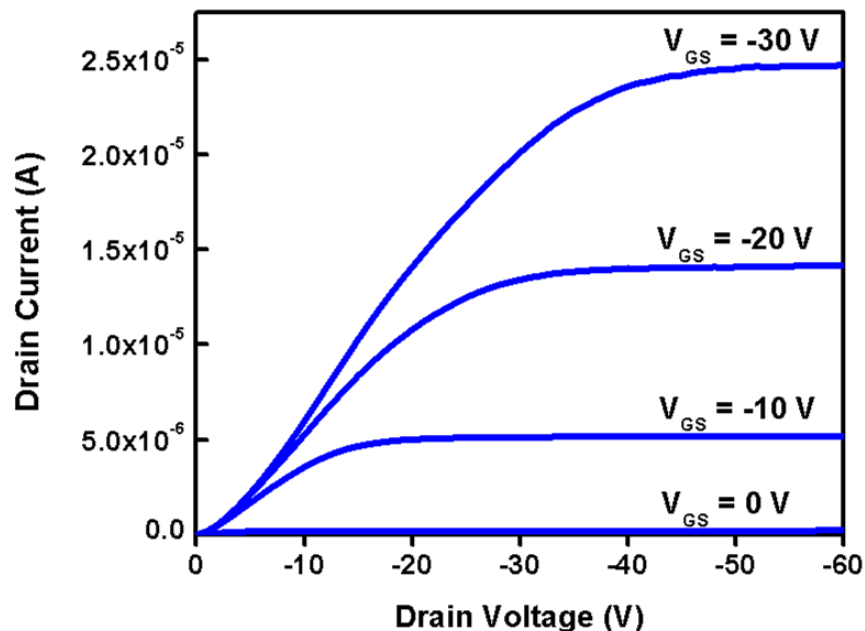
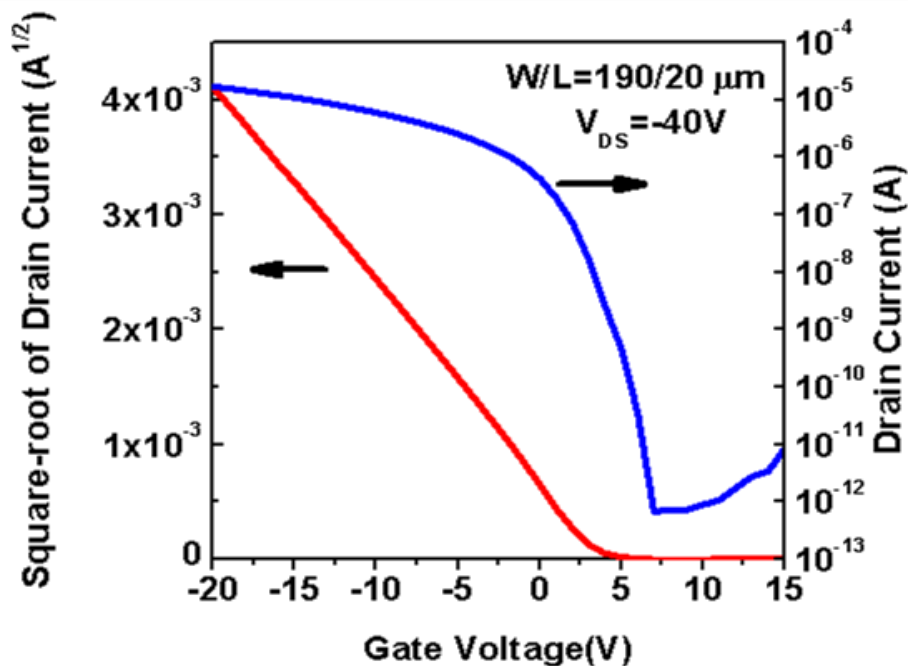
**1 wt% in mixed solvents**

**(chlorobenzene:1,2,4-trichlorobenzene=1:1)**

**UV-ozone treated surface**

**Closely spaced drops merge to form large drop**

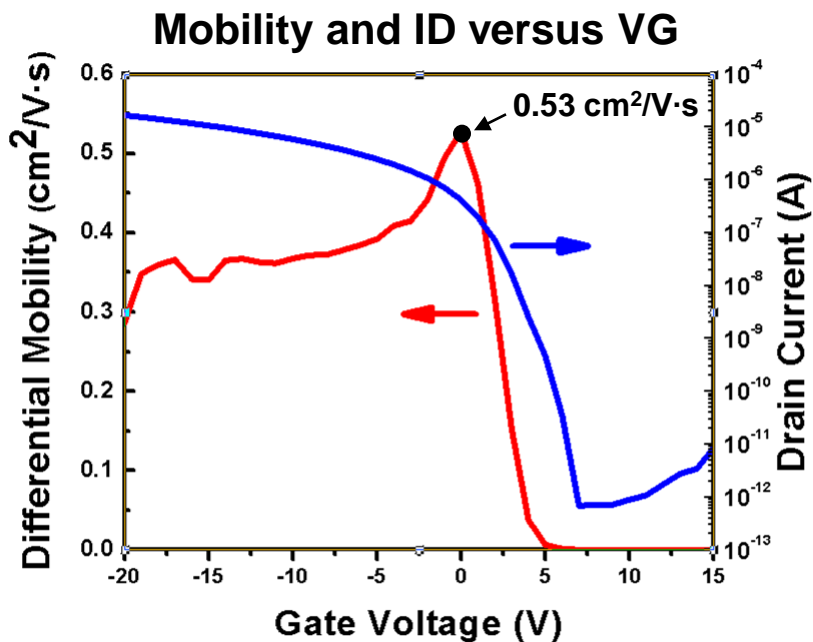
$\mu = 0.42 \text{ cm}^2/\text{V}\cdot\text{s}$ ,  $V_{th} \sim 3 \text{ V}$ ,  
 $I_{on}/I_{off} > 10^7$ ,  $S < 1 \text{ V/dec}$



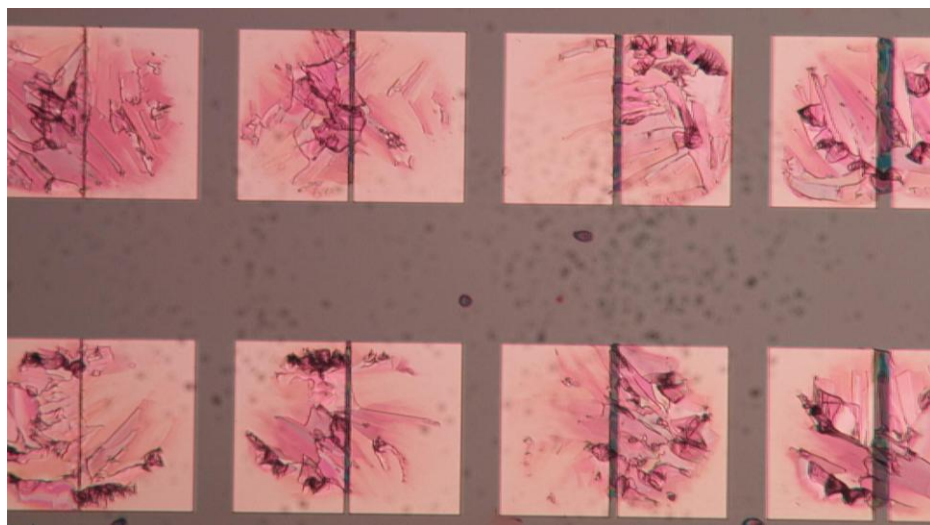
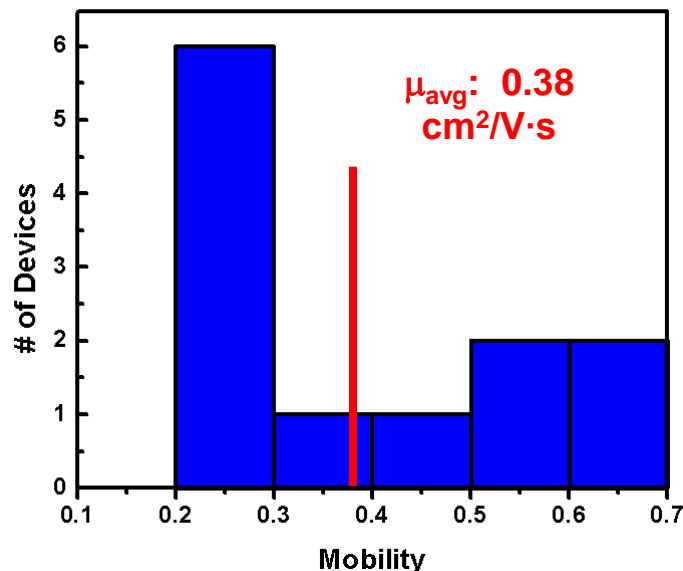


# Uniformity

## Significant device-to-device variation



## Peak mobility statistics



## Need to improve film growth

- Bring PFBT and HMDS treatment back or other surface treatments
- Other solvents

Improvement likely, but there is another problem to consider

# Organic Semiconductor Competition

Pentacene OTFT backplane



Sony - 2007

Polyester substrate

Indium gallium zinc oxide (IGZO) TFT backplane



LG - 2007

Stainless steel substrate

IGZO TFT backplane

## Oxide semiconductors:

- Low temperature process ( $\sim 200$  °C)
- High mobility ( $>10$  cm<sup>2</sup>/V·s)
- Good uniformity
- Good stability
- Strong competitor for organic electronics



Samsung - 2009

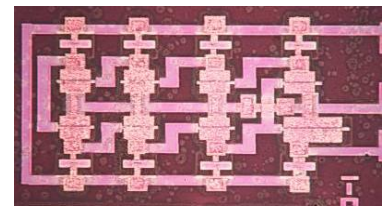
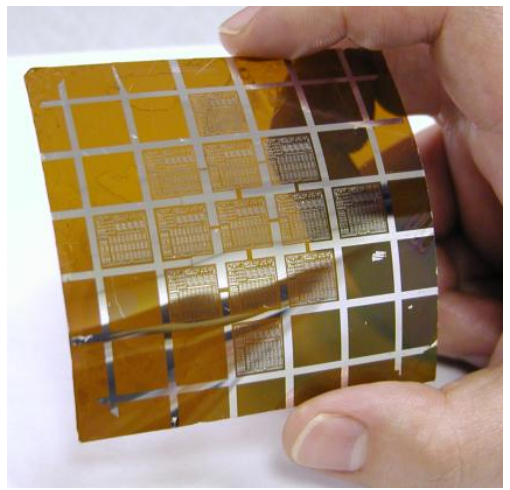
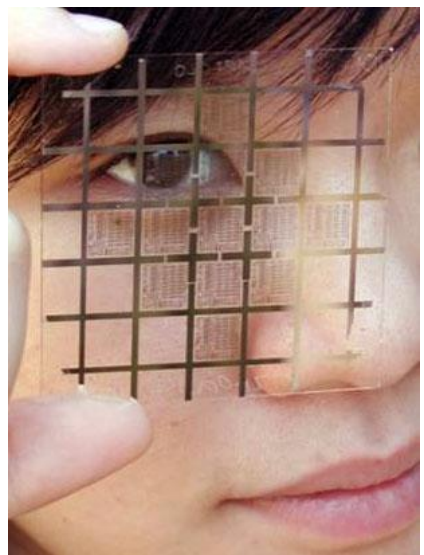
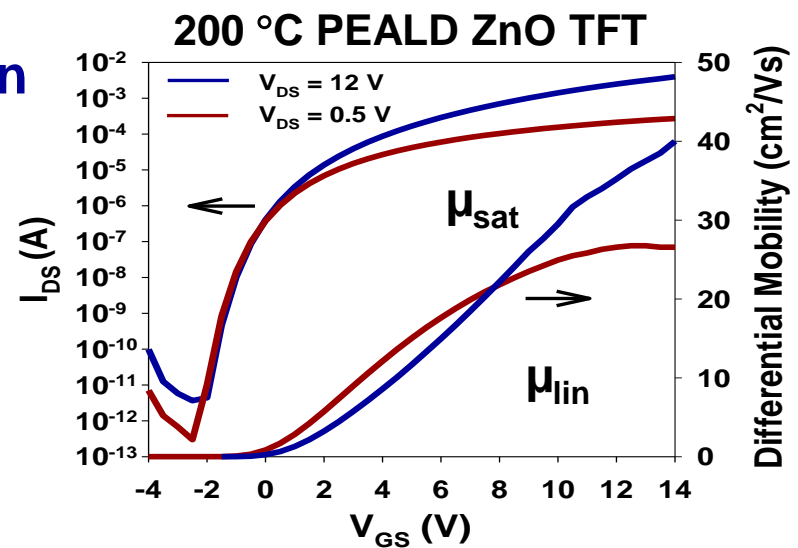
Polyimide substrate

# PSU PEALD ZnO TFTs and Circuits

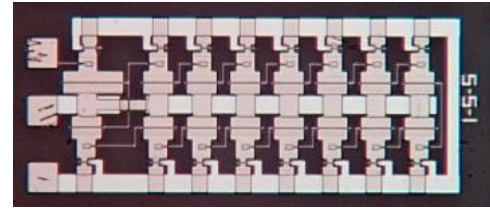
Simple, low cost, low temperature process, high mobility, and fast circuits

## Plasma enhanced atomic layer deposition

- Simple, non-critical process
- Low temperature and large area
- Excellent uniformity
- High mobility, stable ZnO TFTs



Organic TFT ring oscillator



ZnO TFT ring oscillator

## Circuit propagation delay

Organic TFTs few  $\mu\text{s}/\text{stage}$

ZnO TFTs few tens of ns/stage

What role for organics?

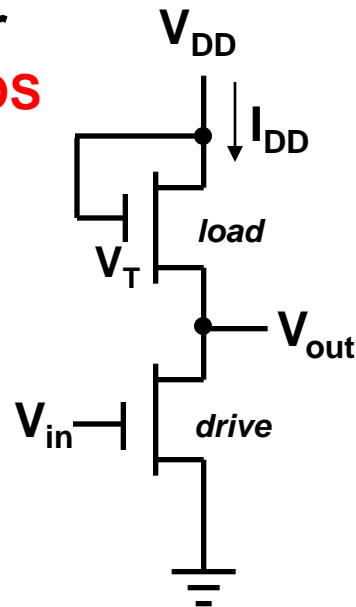
# One role: CMOS!

## CMOS provides critical advantages for digital and analog circuits

### Unipolar inverter

*Either NMOS or PMOS*

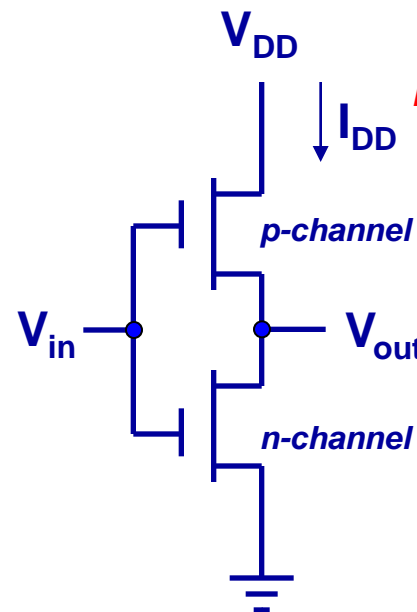
- $I_{DD} \neq 0$  for low output
- $V_{HIGH} \sim V_{DD} - V_T$
- $V_{LOW}$  circuit dependent



### CMOS inverter

*Both NMOS and PMOS*

- $I_{DD} \sim 0$  for both low & high output
- $V_{HIGH} \sim V_{DD}$
- $V_{LOW} \sim 0$



### CMOS advantages:

- Logic level conservation
- Low power for digital circuits
- Simple circuit design
- High gain analog circuits



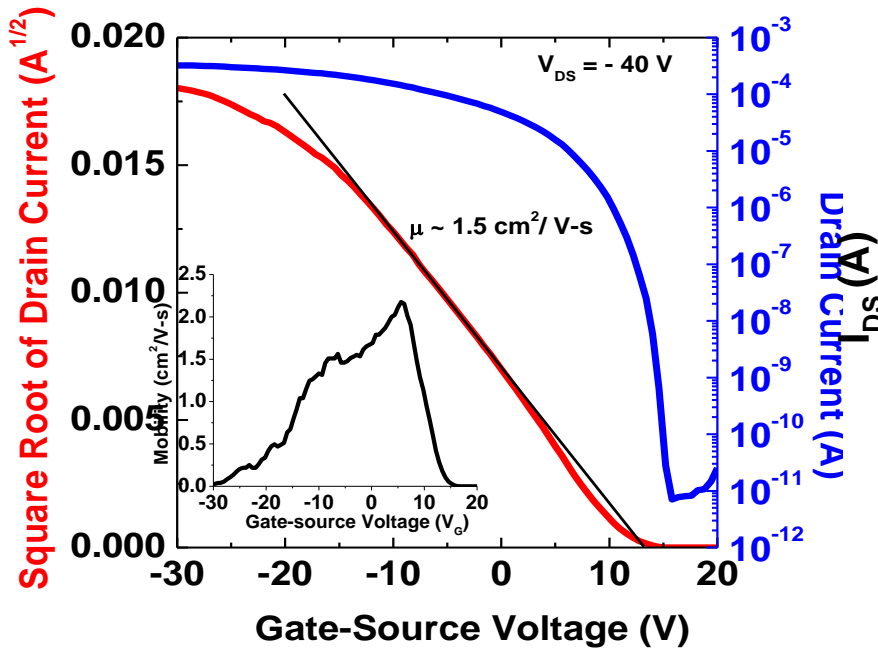
# Hybrid Organic – Inorganic CMOS

Low cost, low temperature CMOS needed

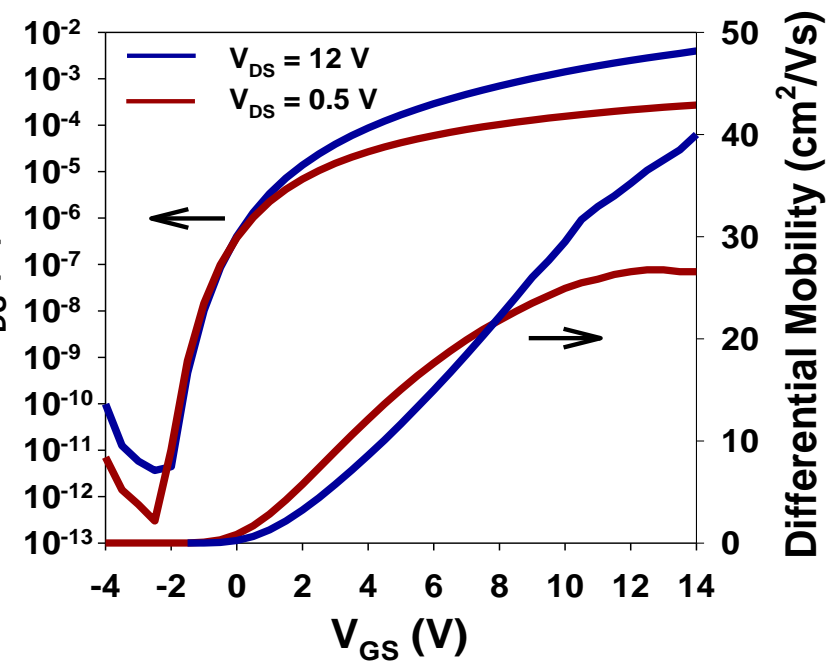
No all-oxide semiconductor CMOS demonstrated

All-organic CMOS has low performance

High mobility p-channel diF TES-ADT



High mobility n-channel PEALD ZnO



Simple idea: combine p-channel diF TES-ADT TFTs and n-channel ZnO TFTs

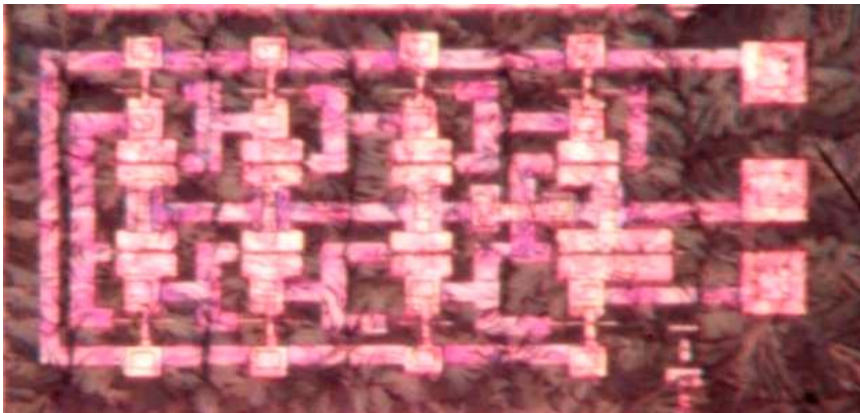
# ZnO and Spin Coated diF TES-ADT Hybrid CMOS

First attempt: use diF-TES-ADT differential  $\mu$ -structure with spatial ALD ZnO foundation

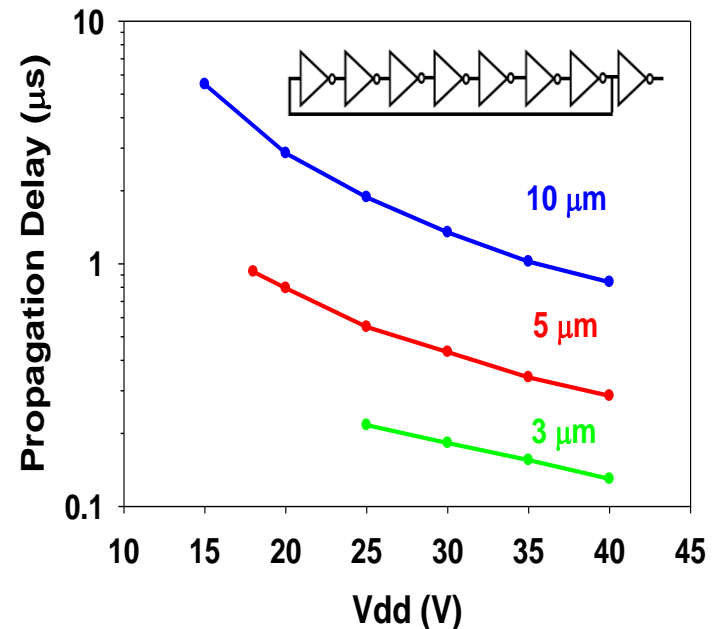
**Hybrid ZnO and spin coated diF TES-ADT CMOS circuits work well and have high speed**

*n*-channel ZnO TFT  
 mobility  $\sim 10 - 15 \text{ cm}^2/\text{V}\cdot\text{s}$

*p*-channel diF TES-ADT TFT  
 mobility  $\sim 0.1 - 0.2 \text{ cm}^2/\text{V}\cdot\text{s}$



7-stage ring oscillator

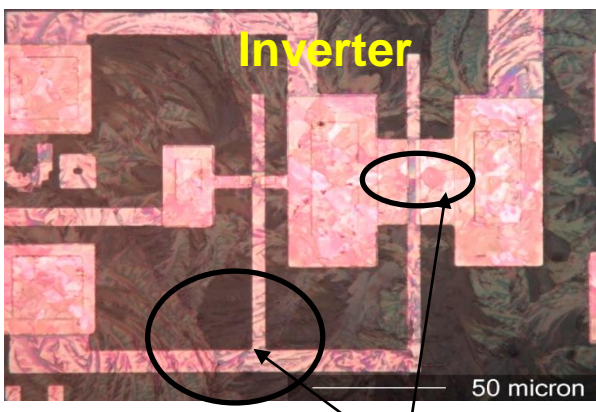
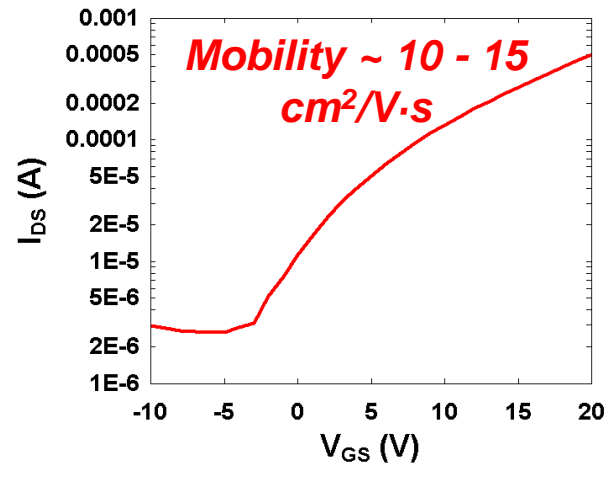
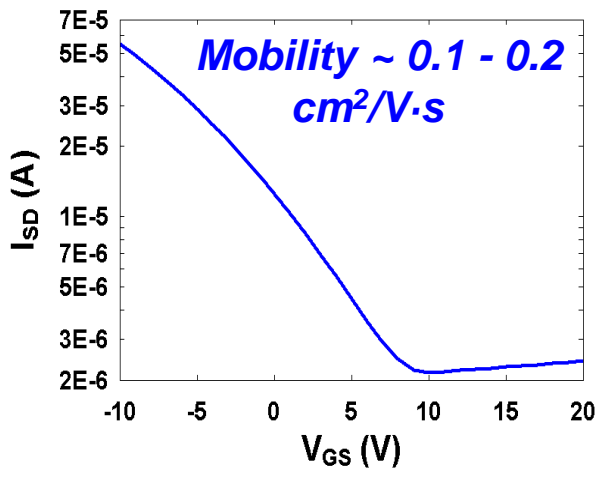


**Minimum propagation delay  $\sim 150 \text{ ns}/\text{stage}$  even with *p*-channel mobility  $\sim 0.2 \text{ cm}^2/\text{V}\cdot\text{s}$**

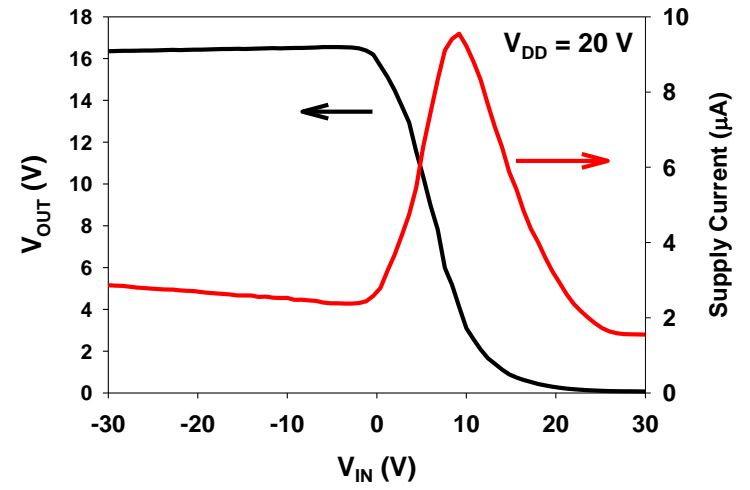
# Spin Coated Organic Hybrid CMOS Problem

diF-TES ADT differential  $\mu$ -structure provides insufficient isolation

→ On and off state leakage, reduced inverter gain



Differential Microstructure

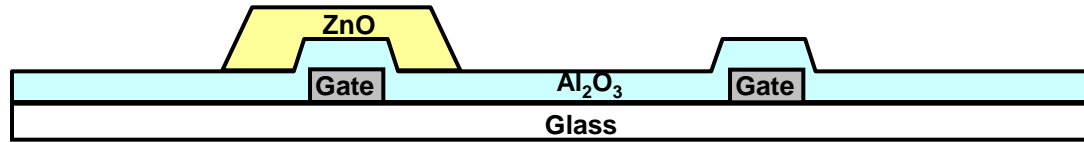


# ZnO/Organic Hybrid CMOS Process

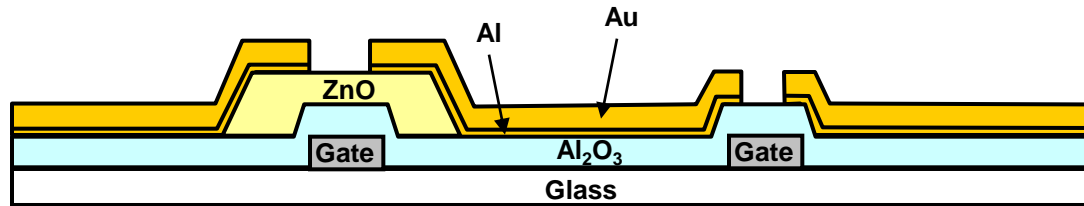
## Simple hybrid CMOS process



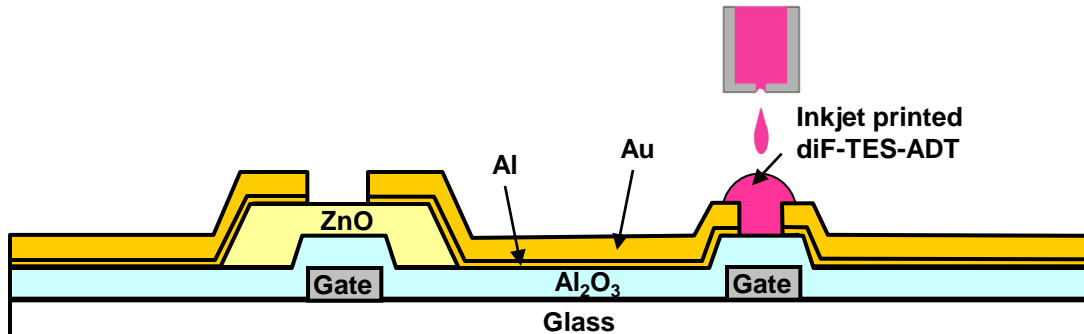
Sputtered nickel gate



PEALD  $\text{Al}_2\text{O}_3$  and ZnO



Bi-functional Al/Au contact



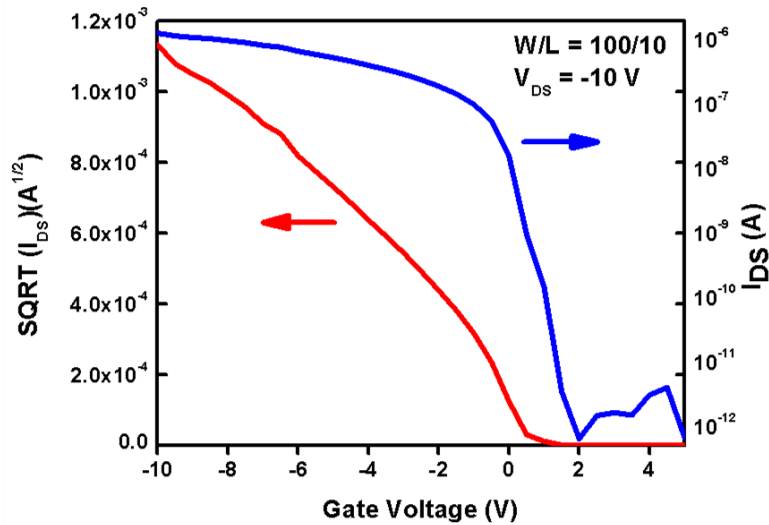
Ink-jet printed diF TES-ADT



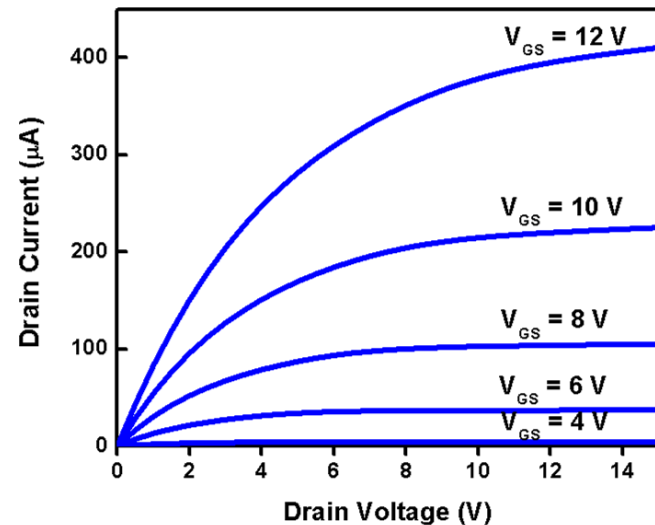
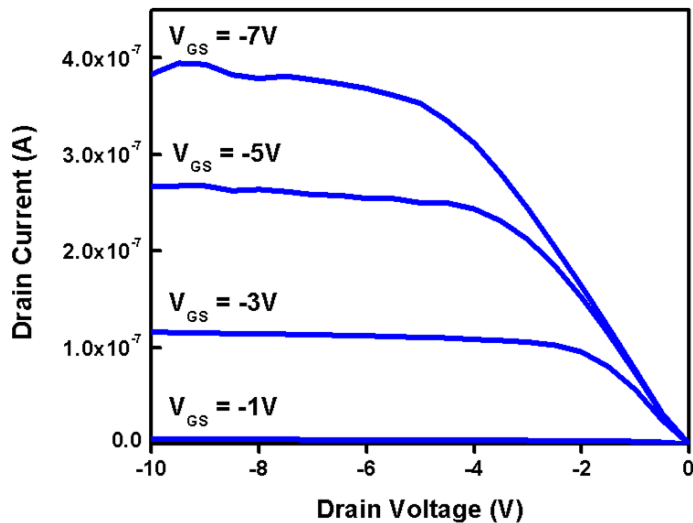
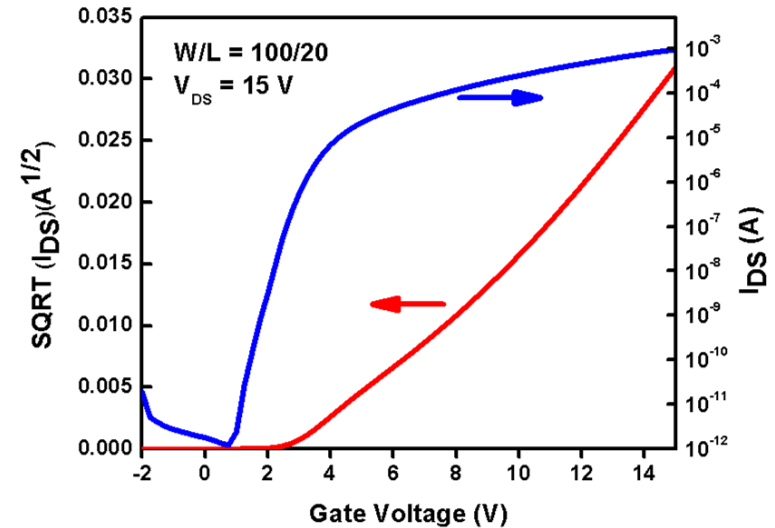
# PEALD ZnO and Ink-Jet Printed TFTs

## Organic performance worse on ZnO circuit structure

**diF TES-ADT (p-channel)**  
*Mobility ~ 0.06 cm<sup>2</sup>/V·s, V<sub>T</sub> ~ 3 V*



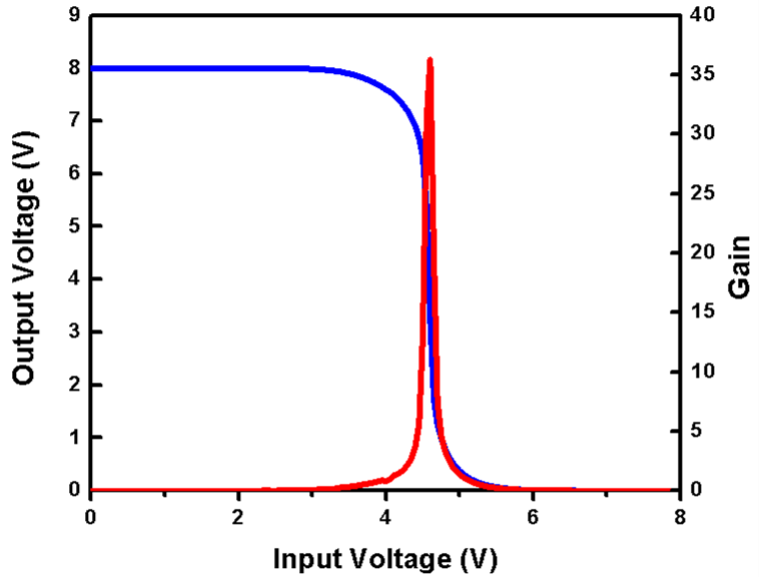
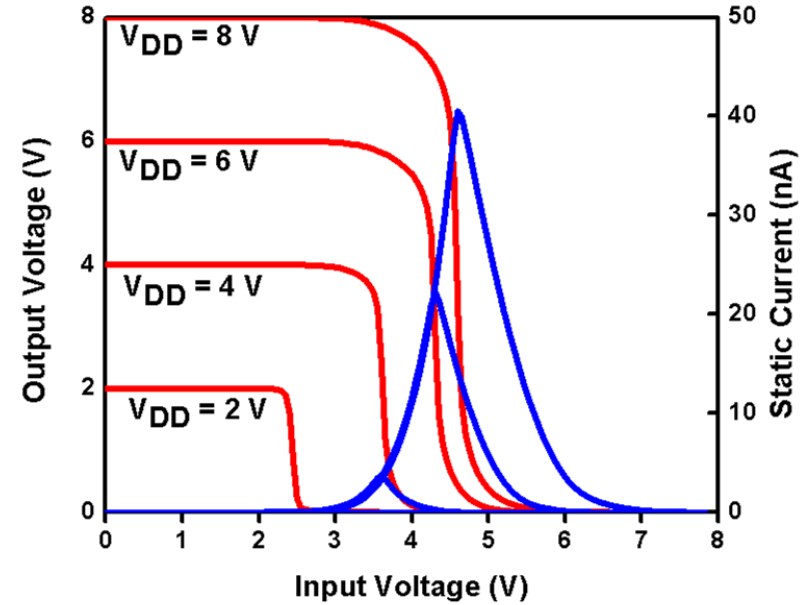
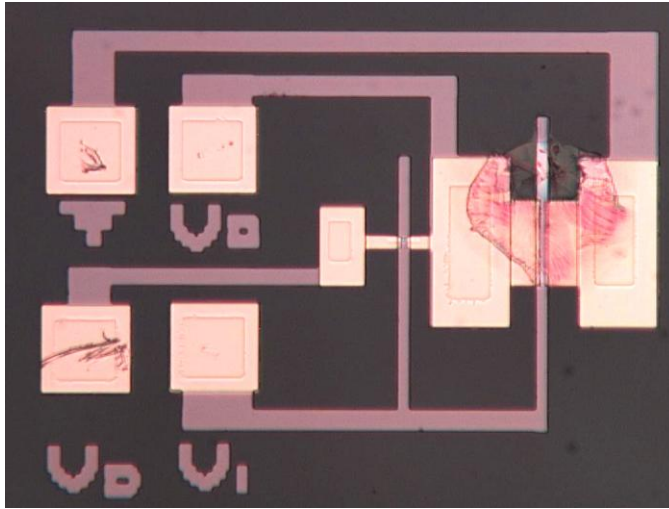
**ZnO (n-channel)**  
*Mobility ~ 17 cm<sup>2</sup>/V·s, V<sub>T</sub> ~ 5 V*





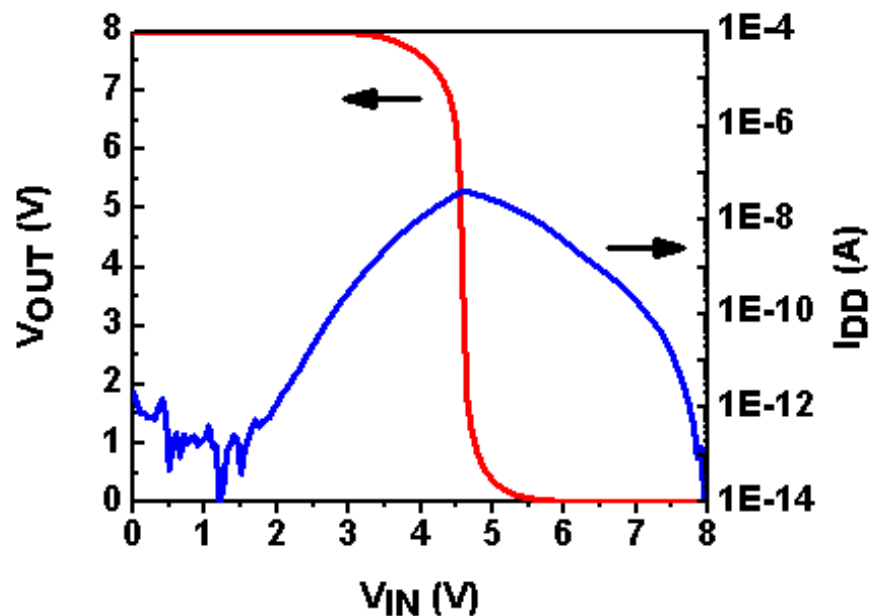
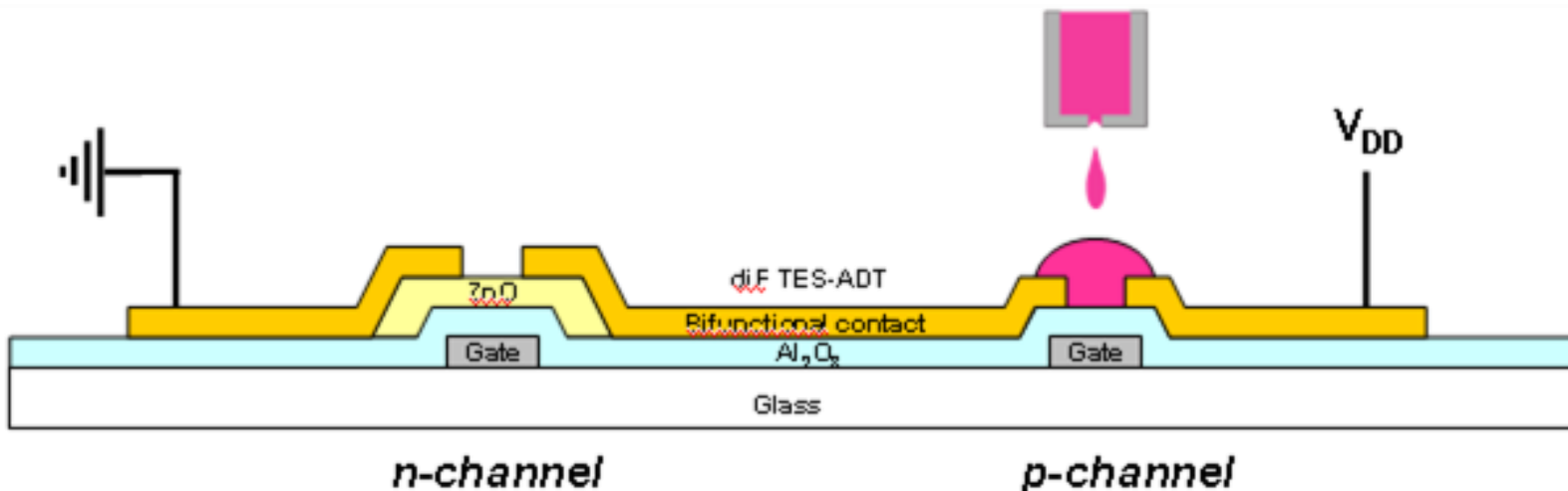
# Printed hybrid CMOS inverter

**Inverters have high gain and low static leakage**



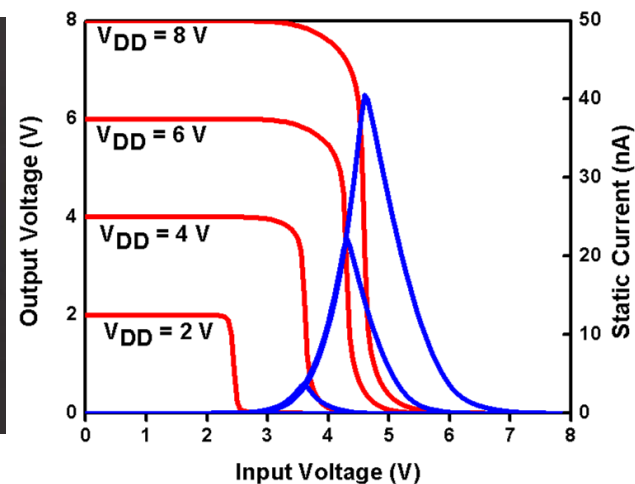
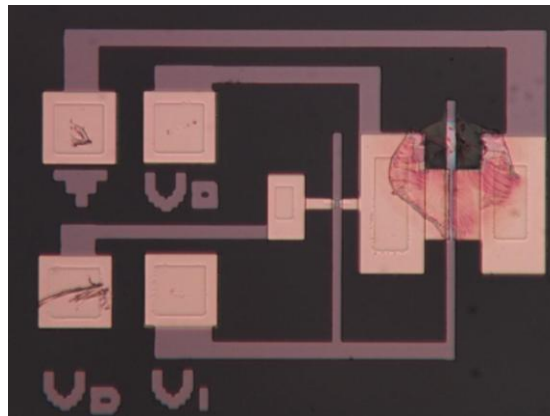
- **Logic level conservation**
- **Static leakage is sub-pA for both low and high input levels (>1000x lower than spin cast)**
- **Maximum gain is about 35**

# Ink-Jet Printed Hybrid Organic-Inorganic CMOS



- Both ZnO and organic deposited at low-temperature
- Bifunctional contact for both ZnO and diF TES-ADT
- Organic layer can be selectively (digitally) patterned
- Only 4 lithography steps are used
- Very low leakage current and relatively high gain

# Summary



- **Small molecule materials are interesting for printed organic semiconductor devices**
- **Control of substrate surface energy and solvent characteristics gives small molecule films with useful morphology**
- **Inkjet printed small molecule organic semiconductor thin film transistors with mobility  $> 0.4 \text{ cm}^2/\text{V}\cdot\text{s}$**
- **PEALD ZnO – inkjet diF TES-ADT hybrid CMOS inverters with high gain and sub-pA leakage**